



**BRIGHTTEK**  
**BRIGHTTEK (EUROPE) LIMITED**

*Brighten up The World With LED!*



ISO/TS 16949:2009



BS EN ISO 14001:2004



QC 080000 IECQ HSPM

## PRODUCT DATASHEET

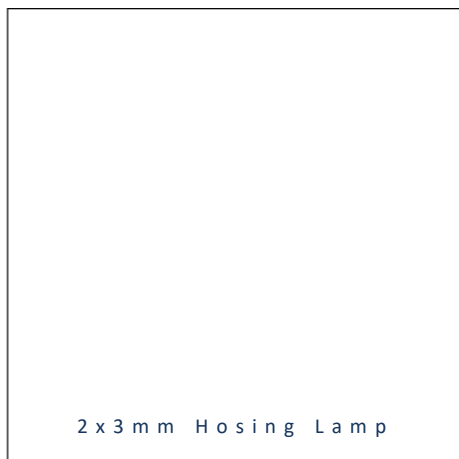


- ▶ PTH Housing Lamp
- ▶ 4x 2x3mm Rectangular Vertical
- ▶ Nul/Red/Yellow/Green

NOM68H58SV



Release Date: 07 January 2025 Version: A1.0



### 2x3mm Housing Lamp

**RoHS**  
Compliant



#### FEATURES:

- **Package:** PTH Housing 4x 2x3mm Rectangular Vertical Lamp
- **Forward Current:** 3x20mA
- **Forward Voltage (typ.):** 2.1/2.2/2.1V\*
- **Luminous Intensity (typ.):** 20/16/18mcd@20mA
- **Colour:** Red/Yellow/Green
- **Dominant Wavelength (typ.):** 625/587/570nm
- **Viewing Angle:** 120°
- **Materials:**
  - Die: GaAsP on GaP/GaAsP on GaP/AlInGaP
  - Resin: Epoxy (Colour Diffused)
- **Operating Temperature:** -40~+85°C
- **Storage Temperature:** -40~+100°C
- **Grouping Parameters:**
  - Forward voltage
  - Luminous intensity
  - Dominant wavelength
- **Soldering Methods:** Hand; Soldering Heat (DIP)
- **Packing:** Loose Pack

\*in order of Red/Yellow/Green.

#### APPLICATIONS:

- Indicator
- Signal
- Side View Application
- Telecom Equipment

## CHARACTERISTICS:

### Absolute Maximum Characteristics (T<sub>a</sub>=25°C)

Parameter	Symbol	Ratings	Unit
Forward Current	I <sub>F</sub>	30/30/25*	mA
Peak Forward Current Duty 1/10@10KHz	I <sub>FP</sub>	100	mA
Reverse Voltage	V <sub>R</sub>	5	V
Reverse Current @5V	I <sub>R</sub>	10	μA
Power Dissipation	P <sub>D</sub>	85	mW
Operating Temperature	T <sub>OPR</sub>	-40~+85	°C
Storage Temperature	T <sub>STG</sub>	-40~+100	°C

\* in order of Red/Yellow/Green.

### Electrical & Optical Characteristics (T<sub>a</sub>=25°C)

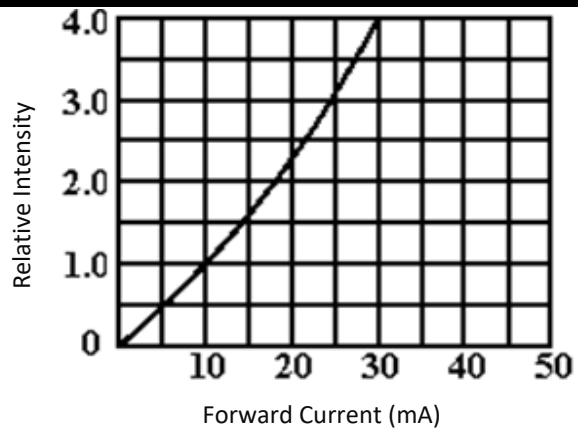
Parameter	Symbol	Values			Unit	Test Condition
		Min.	Typ.	Max.		
Forward Voltage	V <sub>F</sub>	1.8/1.9/1.9*	2.1/2.2/2.1	2.6/2.6/2.6	V	I <sub>F</sub> =20mA
Luminous Intensity	I <sub>V</sub>	15/13/12	20/16/18	25/22/25	mcd	I <sub>F</sub> =20mA
Dominant Wavelength	λ <sub>D</sub>	---	625/570/587	---	nm	I <sub>F</sub> =20mA
Peak Wavelength	λ <sub>P</sub>	---	635/590/568	---	nm	I <sub>F</sub> =20mA
Spectral Line Half Bandwidth	Δλ	---	45/35/19	---	nm	I <sub>F</sub> =20mA
Viewing Angle	2θ <sub>1/2</sub>	---	120	---	deg	I <sub>F</sub> =20mA

\* in order of Red/Yellow/Green.

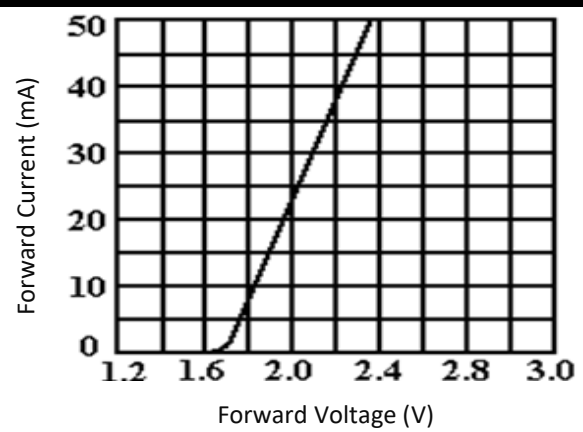


## ELECTRO-OPTICAL CHARACTERISTICS (RED):

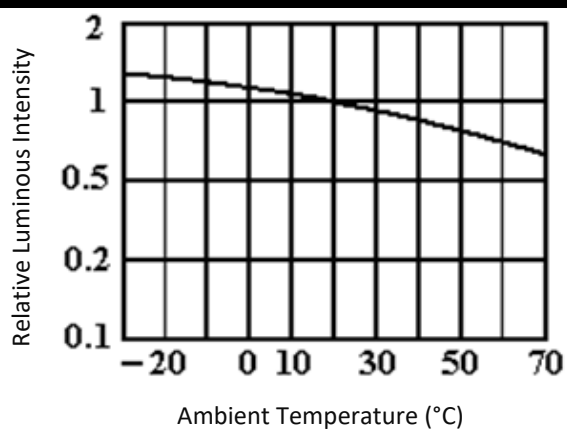
Relative Intensity v.s. Forward Current



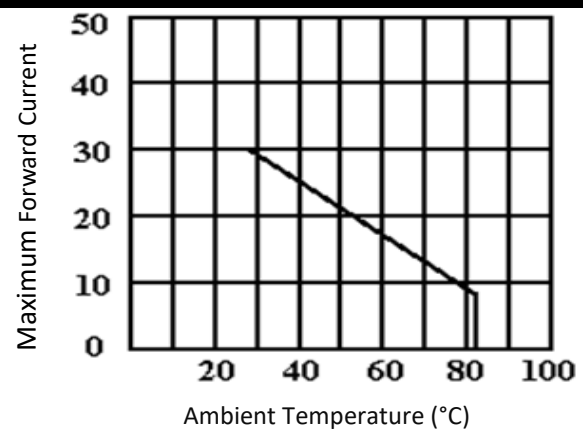
Forward Current v.s. Forward Voltage



Relative Luminous Intensity v.s. Temperature

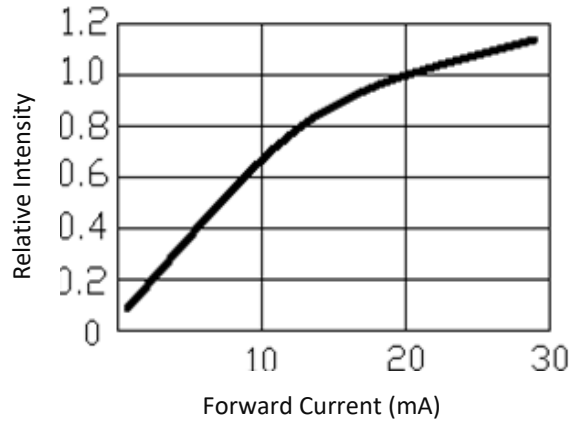


Maximum Forward Current v.s. Temperature

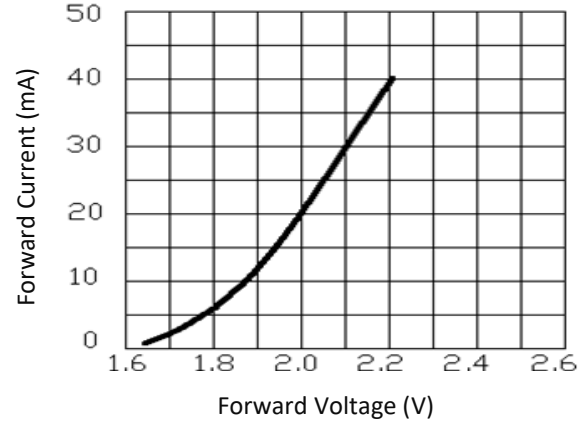


## ELECTRO-OPTICAL CHARACTERISTICS (YELLOW):

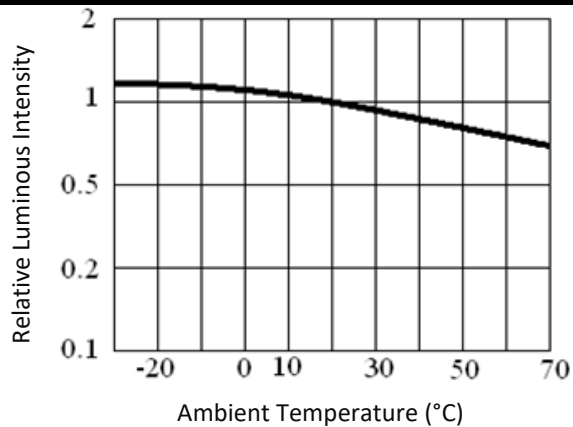
Relative Intensity v.s. Forward Current



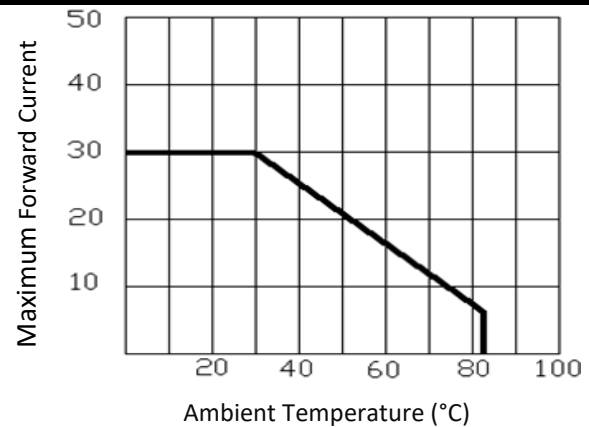
Forward Current v.s. Forward Voltage



Relative Luminous Intensity v.s. Temperature

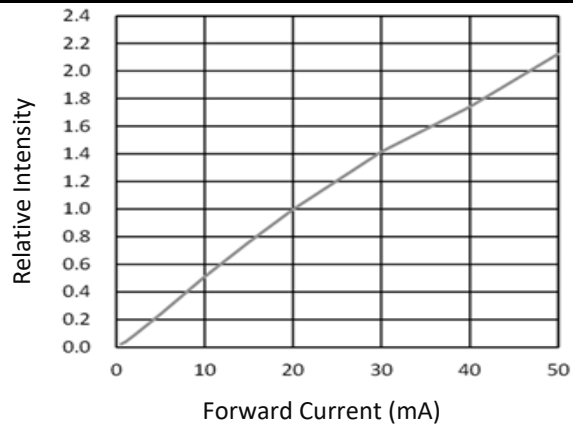


Maximum Forward Current v.s. Temperature

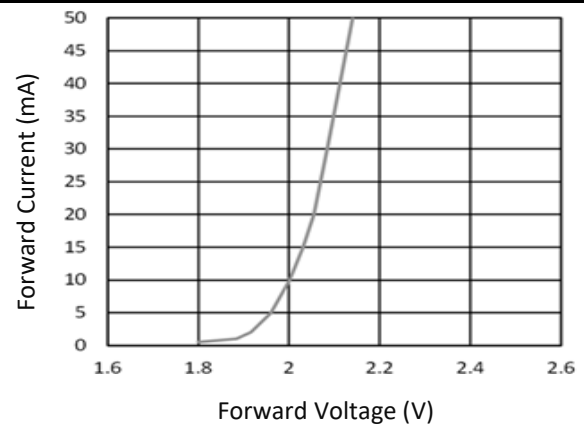


## ELECTRO-OPTICAL CHARACTERISTICS (GREEN):

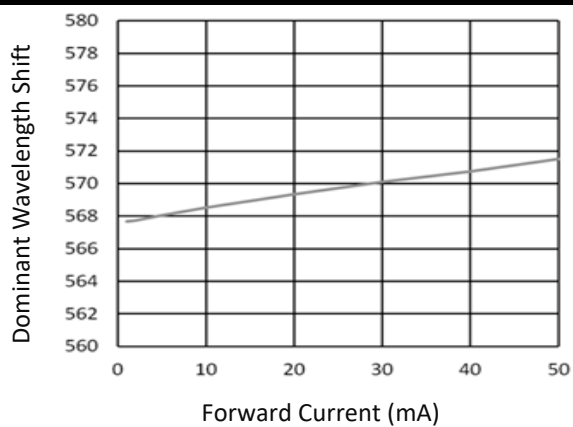
Relative Intensity v.s. Forward Current



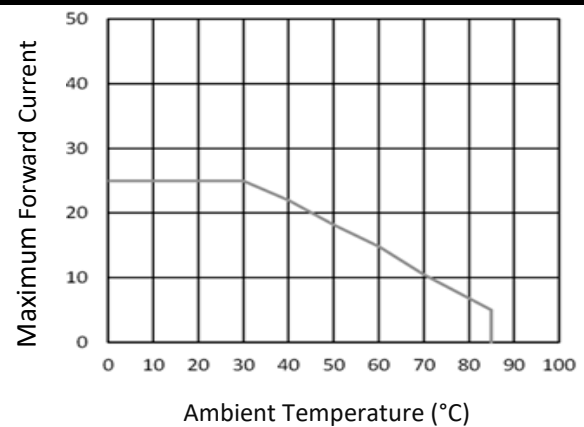
Forward Current v.s. Forward Voltage



Dominant Wavelength v.s. Forward Current



Maximum Forward Current v.s. Temperature





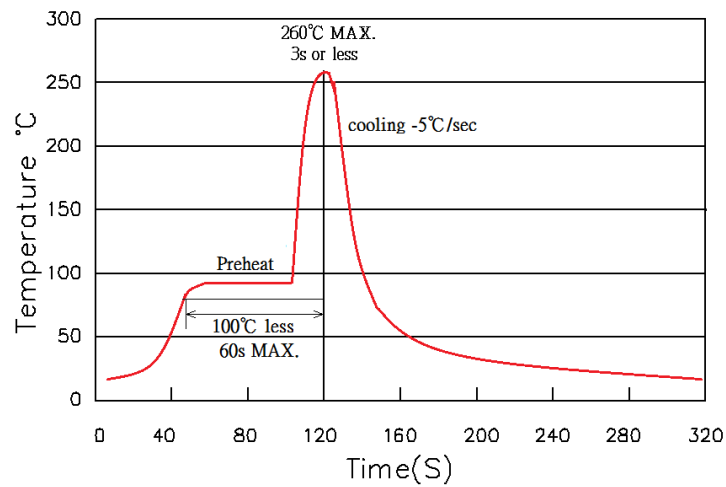
## RECOMMENDED SOLDERING PROFILE:

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### Hand Solder (Solder Iron):

- Temperature at tip of iron: 350°C Max.
- Soldering Time: 3 seconds  $\pm$  1 sec.
- Maximum reflow soldering: 1 time.

### Soldering Heat (DIP):



### Note:

1. Maximum reflow soldering: 1 time.
2. Before, during, and after soldering, should not apply stress on the components and PCB board.

## PRECAUTIONS OF USE:

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### Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with desiccating agent <10% R.H. and apply baking before use.

### Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

- 60±3°C x 6hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

### Testing Circuit:



Must apply resistor(s) for protection (over current proof).

### Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

### ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrostatic glove is recommended when handling the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



**REVISION RECORD:**

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Version	Date	Summary of Revision
A1.0	07/01/2025	Datasheet set-up.